SGM8262-2 High Speed, Ultra-Low Noise, Rail-to-Rail Output, High Output Current Amplifier

GENERAL DESCRIPTION

The SGM8262-2 is a dual, low noise, high speed operational amplifier with voltage feedback function. The output swing is rail-to-rail with heavy loads. This maximizes the dynamic range and offers high linearity.

The SGM8262-2 features 3.5nV/√Hz low voltage noise at 100kHz with ultra-low distortion. It also has 22MHz wide bandwidth at -3dB and 33V/µs high slew rate. The device is unity-gain stable and has high output drive capability.

The SGM8262-2 is available in Green SOIC-8 and TDFN-3×3-8BL packages. It operates over an ambient temperature range of -40°C to +85°C.

FEATURES

Ultra-Low Noise:

Voltage Noise: 3.5nV/√Hz at 100kHz Current Noise: 4pA/√Hz at 100kHz

High Speed:

-3dB Bandwidth: 22MHz (G = +1) Slew Rate: $33V/\mu s$ (R_{LOAD} = 32Ω)

• Unity-Gain Stable

• High Output Current with Excellent Linearity: 310mA

• High Open-Loop Gain: 110dB

• Rail-to-Rail Output

 Support Single or Dual Power Supplies: 4.5V to 36V or ±2.25V to ±18V

• -40°C to +85°C Operating Temperature Range

 Available in Green SOIC-8 and TDFN-3×3-8BL **Packages**

APPLICATIONS

代理商 威尔迈 WV 联系电话 Audio Processing General-Purpose AC Equipment Twisted-Pair Wiring Drivers

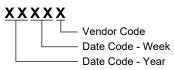


PACKAGE/ORDERING INFORMATION

MODEL	PACKAGE DESCRIPTION	SPECIFIED TEMPERATURE RANGE	ORDERING NUMBER	PACKAGE MARKING	PACKING OPTION
SGM8262-2	SOIC-8	-40°C to +85°C	SGM8262-2YS8G/TR	SGM 82622YS8 XXXXX	Tape and Reel, 2500
3GIVIO202-2	TDFN-3×3-8BL	-40°C to +85°C	SGM8262-2YTDD8G/TR	SGM 82622DD XXXXX	Tape and Reel, 4000

MARKING INFORMATION

NOTE: XXXXX = Date Code and Vendor Code.



Green (RoHS & HSF): SG Micro Corp defines "Green" to mean Pb-Free (RoHS compatible) and free of halogen substances. If you have additional comments or questions, please contact your SGMICRO representative directly.

ABSOLUTE MAXIMUM RATINGS

Supply Voltage	40V
Input Voltage Range (-V _S) - 0.3V	to $(+V_S) + 0.3V$
Input Current (All pins except power supply pin	ns)±10mA
Junction Temperature	+150°C
Storage Temperature Range6	
Lead Temperature (Soldering, 10s)	+260°C
ESD Susceptibility	43
HBM	8000V
MM	400V
CDM	1000V

RECOMMENDED OPERATING CONDITIONS

Operating Temperature Range-40°C to +85°C

OVERSTRESS CAUTION

Stresses beyond those listed in Absolute Maximum Ratings may cause permanent damage to the device. Exposure to absolute maximum rating conditions for extended periods may affect reliability. Functional operation of the device at any conditions beyond those indicated in the Recommended Operating Conditions section is not implied.

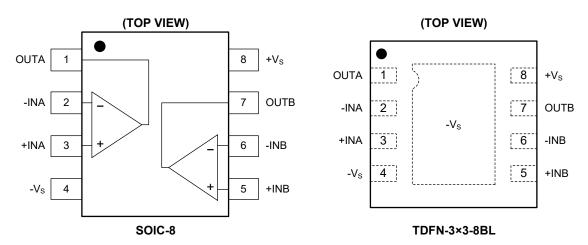
ESD SENSITIVITY CAUTION

This integrated circuit can be damaged if ESD protections are not considered carefully. SGMICRO recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage. ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because even small parametric changes could cause the device not to meet the published specifications.

DISCLAIMER

SG Micro Corp reserves the right to make any change in circuit design, or specifications without prior notice.

PIN CONFIGURATIONS



NOTE: For TDFN-3×3-8BL package, connect thermal die pad to -V_S. Connect it to -V_S plane to maximize thermal performance.



ELECTRICAL CHARACTERISTICS

(At $T_A = +25^{\circ}\text{C}$, $V_S = 4.5\text{V}$ to 36V or $V_S = \pm 2.25\text{V}$ to $\pm 18\text{V}$, G = +1, $R_{LOAD} = 32\Omega$, $V_{CM} = V_{OUT} = V_S/2$, unless otherwise noted.) (1)

PARAMETER	CONDITIONS	MIN	TYP	MAX	UNITS		
DC Performance							
			±100	±500	.,		
Input Offset Voltage (Vos)	-40°C to +85°C			±610	μV		
Input Offset Voltage Match			±100	±700	μV		
Input Offset Voltage Drift (ΔV _{OS} /ΔT)			0.5		μV/°C		
lead Die Comment (L.)	$V_{CM} = V_S/2$		±40	±300)		
Input Bias Current (I _B)	-40°C to +85°C			±370	nA		
Input Offset Current (I _{OS})	$V_{CM} = V_S/2$		±10	±120	nA		
	$V_{OUT} = \pm 1V$, $V_S = \pm 2.5V$ or 5V	109	115				
Open-Loop Voltage Gain (A _{OL})	V _{OUT} = ±2V, V _S = ±5V or 10V	106	115		dB		
	V _{OUT} = ±3V, V _S = ±18V or 36V	95	110				
Input Characteristics					•		
Differential leaves have a	V _S = ±2.25V or 4.5V		38 20		LO 11 F		
Differential Input Impedance	V _S = ±18V or 36V		45 15	\mathbf{Q}	kΩ∥pF		
Common Mada Innut Impadance	V _S = ±2.25V or 4.5V	: 0	4 6		CO [
Common Mode Input Impedance	V _S = ±18V or 36V	110	20 5	70	GΩ II pF		
Input Common Mode Voltage Range (V _{CM})	1/13	(-V _S) + 2	57	(+V _S) - 2	V		
Common Mada Dainatian Datia (CMDD)	$\Delta V_{CM} = \pm 0.5 V$, $V_{S} = \pm 2.5 V$ or 5V	107	130				
Common Mode Rejection Ratio (CMRR)	$\Delta V_{CM} = \pm 1V$, $V_S = \pm 18V$ or $36V$	125		dB			
Output Characteristics	120 -				•		
Output Voltage Swing from Rail (V _{он})	57 200 1/2 10 5/4 10/4		0.72	1.1	V		
Output Voltage Swing from Rail (V _{OL})	$R_{LOAD} = 32\Omega$, $V_S = \pm 2.5V$ to $\pm 5V$ or $V_S = 5V$ to $10V$		0.51	0.64	V		
Output Voltage Swing from Rail (V _{OH})	P. 4000		1.1	1.6	V		
Output Voltage Swing from Rail (V _{OL})	$R_{LOAD} = 100\Omega$		0.8	1	V		
-	SFDR \leq -65dBc, f = 100kHz, $V_{OUT} = 0.4V_{P-P}$,		200		- mA		
Peak AC Output Current (2)	R_{LOAD} = 1Ω, V_S = ±2.25V or 4.5V SFDR ≤ -55dBc, f = 100kHz, V_{OUT} = 20V _{P-P} , R_{LOAD} = 32Ω, V_S = ±12V or 24V		310				
Dynamic Performance					•		
-3dB Gain-Bandwidth Product	$V_{OUT} = 0.1V_{P-P}$		22		MHz		
0.1dB Flatness	$V_{OUT} = 0.1V_{P-P}$		1.6		MHz		
Lawrence Circumst Daniel de State	$V_{OUT} = 0.5V_{P-P}, V_S = \pm 2.25V \text{ or } 4.5V$		23		N41.1-		
Large-Signal Bandwidth	$V_{OUT} = 2V_{P-P}, V_S = \pm 18V \text{ or } 36V$		12		MHz		
	$V_{OUT} = 0.5V_{P-P}, V_S = \pm 2.25V \text{ or } 4.5V$		27				
0	$V_{OUT} = 1V_{P-P}, V_S = \pm 2.5V \text{ or } 5V$		33		=		
Slew Rate (SR)	$V_{OUT} = 4V_{P-P}, V_S = \pm 5V \text{ or } 10V$		49		V/µs		
	$V_{OUT} = 4V_{P-P}, V_S = \pm 12V \text{ or } 24V$		34		1		
Noise/Distortion Performance				I.			
	$f_C = 100kHz$, $V_{OUT} = 1V_{P-P}$, $G = +2$, $V_S = \pm 2.25V$ or 4.5V		-95				
D	$f_C = 100kHz$, $V_{OUT} = 2V_{P-P}$, $G = +2$, $V_S = \pm 2.5V$ or $5V$		-93				
Distortion (Worst Harmonic)	$f_C = 100kHz$, $V_{OUT} = 6V_{P-P}$, $G = +2$, $V_S = \pm 5V$ or $10V$		-88		dBc		
	$f_C = 100kHz$, $V_{OUT} = 20V_{P-P}$, $G = +5$, $V_S = \pm 12V$ or 24V		-52				
Input Voltage Noise Density (en)	f = 100kHz		3.5		nV/√Hz		
Input Current Noise Density (in)	f = 100kHz		4		pA/ _{√Hz}		

ELECTRICAL CHARACTERISTICS (continued)

(At $T_A = +25^{\circ}C$, $V_S = 4.5V$ to 36V or $V_S = \pm 2.25V$ to $\pm 18V$, G = +1, $R_{LOAD} = 32\Omega$, $V_{CM} = V_{OUT} = V_S/2$, unless otherwise noted.) (1)

PARAMETER	CONDITIONS	MIN	TYP	MAX	UNITS
Power Supply					
Operating Voltage Range (Dual Supply)		±2.25		±18	V
Supply Current/Amplifier (I _Q)			9	11.5	mA
Power Supply Rejection Ratio (PSRR)	$\Delta V_S = \pm 0.5 V$	100	115		dB
Audio Performance					
	$f = 1kHz$, $V_{OUT} = 0.5V_{P-P}$, $V_S = \pm 2.25V$ or 4.5V,		0.0006		%
	W = 80kHz		-104		dB
	5 411 V 4V V 10 5V 5V 5W 0011		0.0003		%
Total Harmania Distortion - Naisa (THD IN)	$f = 1kHz$, $V_{OUT} = 1V_{P-P}$, $V_S = \pm 2.5V$ or 5V, BW = 80kHz		-110		dB
Total Harmonic Distortion + Noise (THD+N)	f - 4kH= \		0.00005		%
	$f = 1kHz$, $V_{OUT} = 6V_{P-P}$, $V_S = \pm 5V$ or 10V, BW = $80kHz$		-126		dB
	f = 4141= 1/ = 21/ 1/ = 24/ PM = 2014 =		0.00005		%
	$f = 1kHz, V_{OUT} = 3V_{RMS}, V_{S} = \pm 12V \text{ or } 24V, BW = 80kHz$		-126		dB

NOTES:

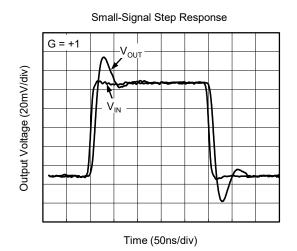
_ or greater to improve stability. 1. Unity-gain can promote characterization. It is recommended to use a gain of 2 or greater to improve stability.

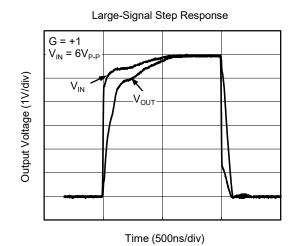
2. Peak AC output current is only for normal AC operation, and continuous DC operation is invalid.

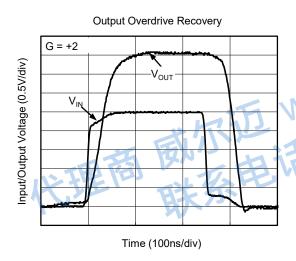


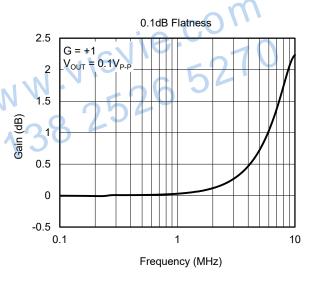
TYPICAL PERFORMANCE CHARACTERISTICS

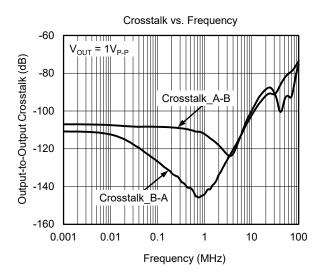
At T_A = +25°C, V_S = ±5V, R_{LOAD} = 32 Ω , unless otherwise noted.

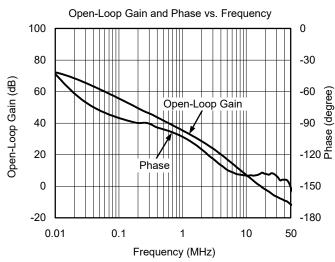






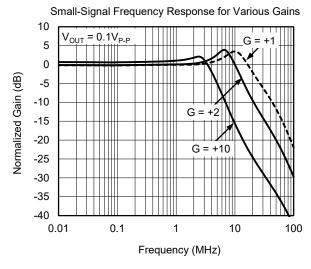


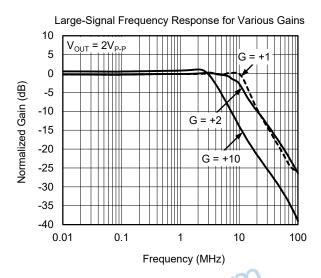


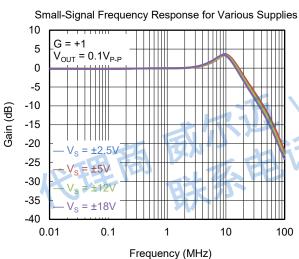


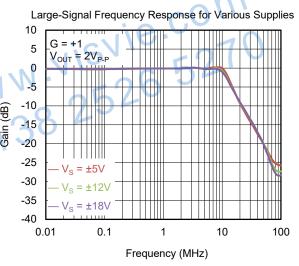
TYPICAL PERFORMANCE CHARACTERISTICS (continued)

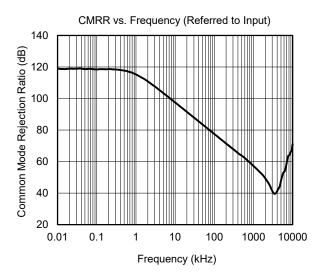
At $T_A = +25$ °C, $V_S = \pm 5V$, $R_{LOAD} = 32\Omega$, unless otherwise noted.

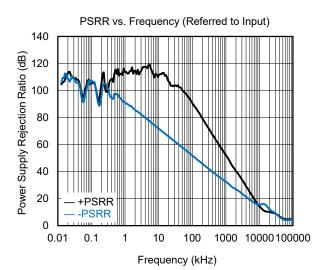






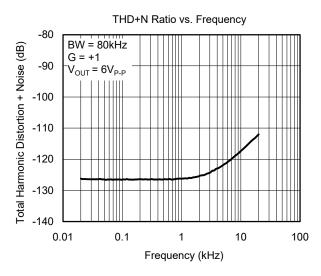


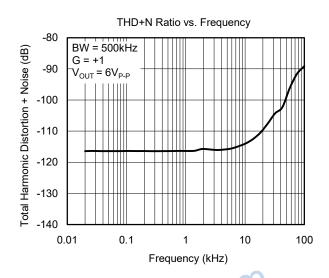


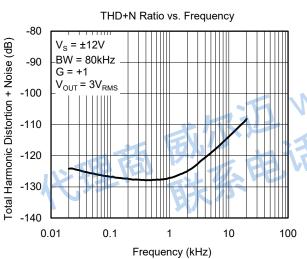


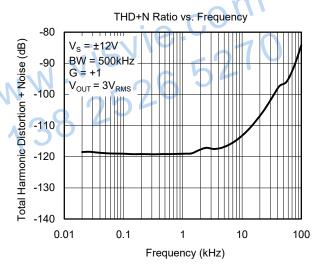
TYPICAL PERFORMANCE CHARACTERISTICS (continued)

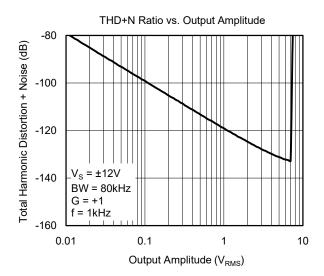
At $T_A = +25$ °C, $V_S = \pm 5V$, $R_{LOAD} = 32\Omega$, unless otherwise noted.











APPLICATION INFORMATION

The SGM8262-2 is a dual, low noise, high speed operational amplifier with voltage feedback function. The output swing is rail-to-rail with heavy loads. The SGM8262-2 is optimized for high voltage operation from $\pm 2.25 \text{V}$ to $\pm 18 \text{V}$ dual supplies.

Power Supply and Decoupling

The supported voltage of the power supply for SGM8262-2 is from ± 2.25 V to ± 18 V. Also, the customer should ensure that the source of the power supply is low noise and well-regulated. The power supply should be decoupled suitably. The power supply ripple and power dissipation can be decreased dramatically by using low ESR capacitor. The multilayer ceramic capacitors (MLCCs) are good choices for decoupling. A 0.1 μ F MLCC capacitor should be placed as close as possible (0.125 inches) to the power supply pin of the SGM8262-2. For decoupling the low-frequency signals, 10μ F to 22μ F tantalum capacitors should be taken into account so that it can convey the current for large and fast signal changes.

Layout

A good PCB layout is important for the performance of SGM8262-2 in high speed applications in order to prevent the parasitic effects from the board. The PCB should have a low impedance loop (or ground) to the power supply. Removing the GND planes for all of the layers of the PCB board can simply reduce the stray capacitors. Also, the PCB traces should be placed as short as possible in order to reduce parasitic inductance and capacitance. The resistors or loads should be placed as close as possible to the terminals of the SGM8262-2. The input traces of the SGM8262-2 should be placed away from the output trace to minimize coupling (crosstalk).

If the SGM8262-2 is used for differential driver, the customers should be placed as close as (0.125 inches) to the power supply pin of the 2-2. For decoupling the low-frequency signals, 22µF tantalum capacitors should be taken into so that it can convey the current for large and all changes.

If the SGM8262-2 is used for differential driver, the customers should guarantee the symmetrical layout to obtain better output performance. If the trace for the differential signal is long, please make sure that place the two differential traces as close as possible, or twist them together in order to reduce the inductive loop. The above method can enhance the anti-interference ability for RF signal by reducing the radiated energy. It is recommended to use strip line for the signal trace which is longer than 1 inch.



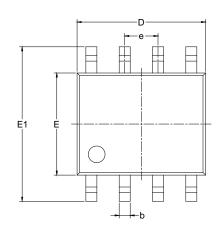
REVISION HISTORY

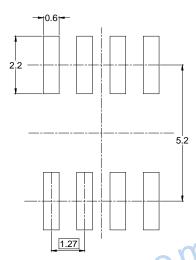
NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

MARCH 2023 – REV.A to REV.A.1	Page
Updated Typical Performance Characteristics section	7
Changes from Original (JUNE 2017) to REV.A	Page
Changed from product preview to production data	All

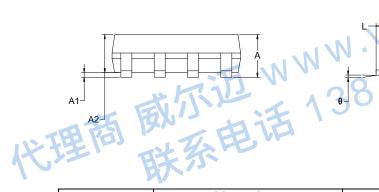


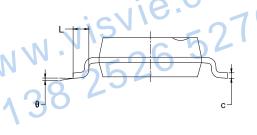
PACKAGE OUTLINE DIMENSIONS SOIC-8





RECOMMENDED LAND PATTERN (Unit: mm)



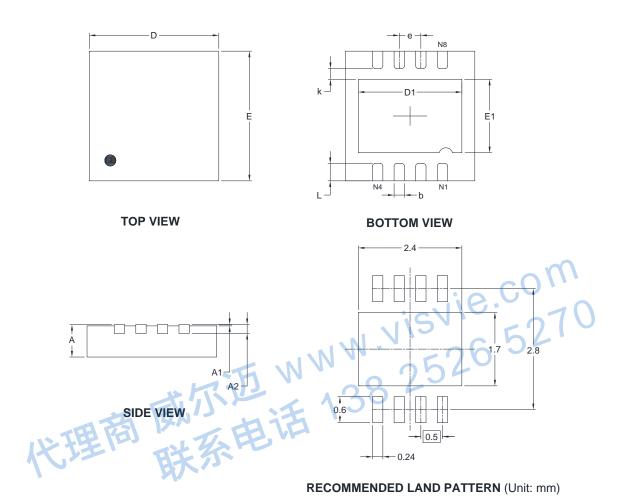


Symbol		nsions meters	Dimensions In Inches		
	MIN	MAX	MIN	MAX	
А	1.350	1.750	0.053	0.069	
A1	0.100	0.250	0.004	0.010	
A2	1.350	1.550	0.053	0.061	
b	0.330	0.510	0.013	0.020	
С	0.170	0.250	0.006	0.010	
D	4.700	5.100	0.185	0.200	
Е	3.800	4.000	0.150	0.157	
E1	5.800	6.200	0.228	0.244	
е	e 1.27		0.050	BSC	
L	0.400	1.270	0.016	0.050	
θ	0°	8°	0°	8°	

NOTES

- 1. Body dimensions do not include mode flash or protrusion.
- 2. This drawing is subject to change without notice.

PACKAGE OUTLINE DIMENSIONS TDFN-3×3-8BL



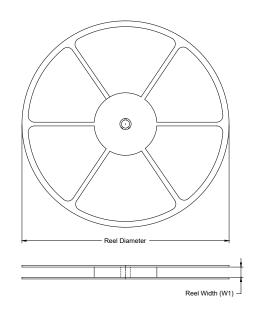
Symbol		nsions meters	Dimensions In Inches		
	MIN	MAX	MIN	MAX	
А	0.700	0.800	0.028	0.031	
A1	0.000	0.050	0.000	0.002	
A2	A2 0.203 REF			REF	
D	2.900	3.100	0.114	0.122	
D1	2.300	2.500	0.091	0.098	
E	2.900	3.100	0.114	0.122	
E1	1.600	1.800	0.063	0.071	
k	0.200) MIN	0.008 MIN		
b	0.180	0.300	0.007	0.012	
е	0.500 TYP		0.020	TYP	
L	0.300	0.500	0.012	0.020	

NOTE: This drawing is subject to change without notice.

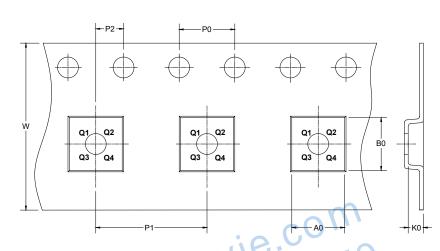


TAPE AND REEL INFORMATION

REEL DIMENSIONS



TAPE DIMENSIONS



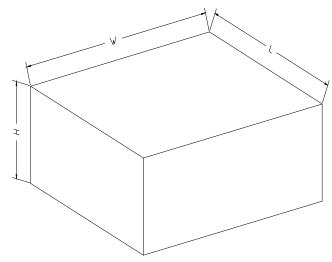
DIRECTION OF FEED

NOTE: The picture is only for reference. Please make the object as the standard.

KEY PARAMETER LIST OF TAPE AND REEL

Package Type	Reel Diameter	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P0 (mm)	P1 (mm)	P2 (mm)	W (mm)	Pin1 Quadrant	
SOIC-8	13"	12.4	6.40	5.40	2.10	4.0	8.0	2.0	12.0	Q1	
TDFN-3×3-8BL	13"	12.4	3.35	3.35	1.13	4.0	8.0	2.0	12.0	Q1	DD0001

CARTON BOX DIMENSIONS



NOTE: The picture is only for reference. Please make the object as the standard.

KEY PARAMETER LIST OF CARTON BOX

KEY PARAMETE	R LIST OF	CARTON B	ОХ	invie.com
Reel Type	Length (mm)	Width (mm)	Height (mm)	Pizza/Carton 52
13"	386	280	370	05 2 logs